



TB0640M - TB3500M

50A BIDIRECTIONAL SURFACE MOUNT THYRISTOR SURGE PROTECTION DEVICE

Features

- 50A Peak Pulse Current @ 10/1000μs
- 250A Peak Pulse Current @ 8/20μs
- 58 320V Stand-Off Voltages
- Oxide-Glass Passivated Junction
- Bidirectional Protection In a Single Device
- High Off-State impedance and Low On-State Voltage
- Helps Equipment Meet GR-1089-CORE, IEC 61000-4-5, FCC Part 68, ITU-T K.20/K.21, and UL497B
- UL Listed Under Recognized Component Index, File Number 156346
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony)
 (Note 2)

Mechanical Data

- Case: SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: None; Bidirectional Devices Have No Polarity Indicator
- Weight: 0.093 grams (approximate)



Top View



Ordering Information (Note 3)

Part Number	Case	Packaging		
TB0640M-13-F	SMB	3000/Tape & Reel		
TB0720M-13-F	SMB	3000/Tape & Reel		
TB0900M-13-F	SMB	3000/Tape & Reel		
TB1100M-13-F	SMB	3000/Tape & Reel		
TB1300M-13-F	SMB	3000/Tape & Reel		
TB1500M-13-F	SMB	3000/Tape & Reel		
TB1800M-13-F	SMB 3000/			
TB2300M-13-F	SMB	3000/Tape & Reel		
TB2600M-13-F SMB		3000/Tape & Reel		
TB3100M-13-F	TB3100M-13-F SMB			
TB3500M-13-F	SMB	3000/Tape & Reel		

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.

2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



xxxx = Product type marking code (See Electrical Characteristics table on page 3))!! = Manufacturers' code marking YWW = Date code marking Y = Last digit of year (ex: 2 for 2002) WW = Week code (01 to 53)



Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

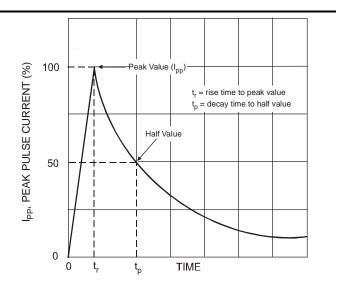
Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.				
Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Impulse Current	@10/1000us	I _{pp}	50	A
Non-Repetitive Peak On-State Current	@8.3ms (one-half cycle)	ITSM	30	A
Typical Positive Temperature Coefficient for Breakdown Voltage		$\Delta VBR/\Delta T_{j}$	0.1	%/°C

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Lead	$R_{\theta JL}$	20	°C/W
Thermal Resistance, Junction to Ambient	$R_{ ext{ heta}JA}$	100	°C/W
Junction Temperature Range	TJ	-40 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	۵°

Maximum Rated Surge Waveform

Waveform	Standard	lpp (A)
2/10 us	GR-1089-CORE	300
8/20 us	IEC 61000-4-5	250
10/160 us	FCC Part 68	150
10/700 us	ITU-T, K.20/K.21	100
10/560 us	FCC Part 68	75
10/1000 us	GR-1089-CORE	50





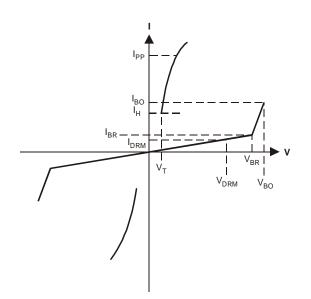
Electrical Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

Part Number	Maximum Rated Repetitive Off-State Voltage	Maximum Off-State Leakage Current @ V _{DRM}	Maximum Breakover Voltage	Maximum On-State Voltage @ I _T = 1A	n-State Breakover Current Lac		Holding		Typical Off-State Capacitance	Marking Code
	V _{DRM} (V)	I _{DRM} (uA)	V _{BO} (V)	V _T (V)	Min (mA)	Max (mA)	Min (mA)	Max (mA)	C _O (pF)	
TB0640M	58	5	77	3.5	50	800	150	800	140	T064M
TB0720M	65	5	88	3.5	50	800	150	800	140	T072M
TB0900M	75	5	98	3.5	50	800	150	800	140	T090M
TB1100M	90	5	130	3.5	50	800	150	800	90	T110M
TB1300M	120	5	160	3.5	50	800	150	800	90	T130M
TB1500M	140	5	180	3.5	50	800	150	800	90	T150M
TB1800M	160	5	220	3.5	50	800	150	800	90	T180M
TB2300M	190	5	265	3.5	50	800	150	800	60	T230M
TB2600M	220	5	300	3.5	50	800	150	800	60	T260M
TB3100M	275	5	350	3.5	50	800	150	800	60	T310M
TB3500M	320	5	400	3.5	50	800	150	800	60	T350M

Symbol	Parameter	
V _{DRM}	Stand-off Voltage	
I _{DRM}	Leakage current at stand-off voltage	
V _{BR}	Breakdown voltage	
I _{BR}	Breakdown current	
V _{BO}	Breakover voltage	
IBO	Breakover current	
lн	Holding current Note 4	
V _T	On state voltage	
Ірр	Peak pulse current	
Co	Off-state capacitance Note 5	

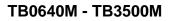
Notes: 4. I_H > (V_L/R_L) If this criterion is not obeyed, the TSPD triggers but does not return correctly to high-resistance state. The surge recovery time does not exceed 30ms.

5. Off-state capacitance measured at f = 1.0MHz, 1.0V_{RMS} signal, V_{\text{R}} = 2V_{DC} bias.





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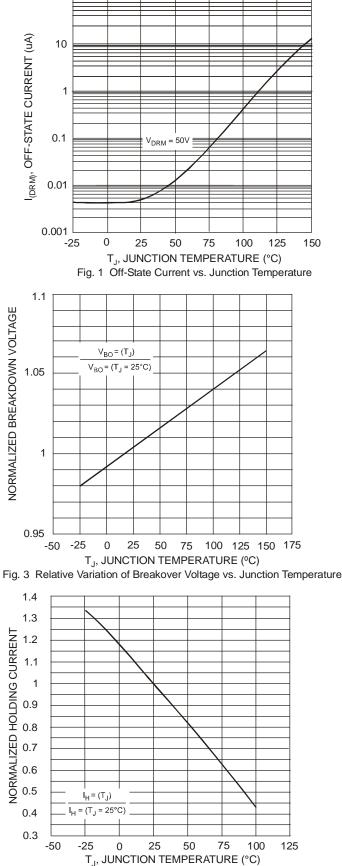


Fig. 5 Relative Variation of Holding Current vs. Junction Temperature Fig. 6 Relative Variation of Junction Capacitance vs. Reverse Voltage Bias

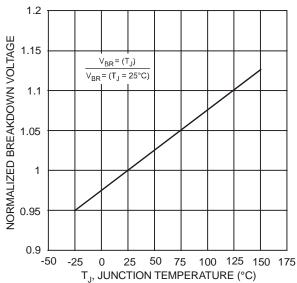
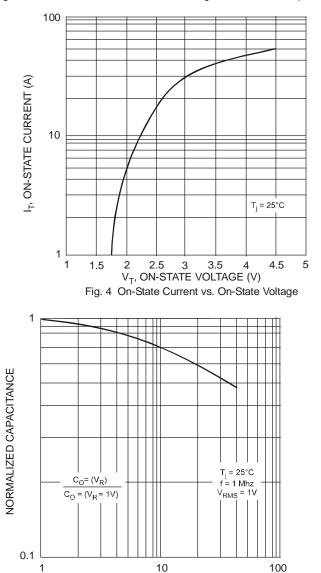


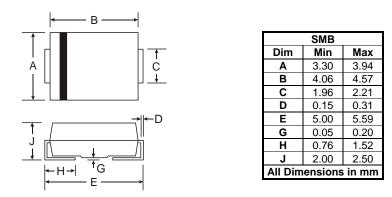
Fig. 2 Relative Variation of Breakdown Voltage vs. Junction Temperature



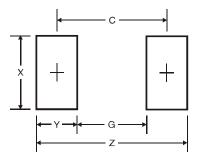
10 V_R , REVERSE VOLTAGE (V)



Package Outline Dimensions



Suggested Pad Layout



SMB Dimensions	Value (in mm)
Z	6.8
G	1.8
Х	2.3
Y	2.5
С	4.3



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